

-	262	(324/751).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:38
-	184	(324/752).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:38
-	0	("01 or 2").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:38
-	428	((324/751).CCLS.) or ((324/752).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:39
-	116	integratednadj1 circuit adj2 die and laser adj2 light	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:40
-	90	integrated adj1 circuit adj2 die and laser adj2 light	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:41
-	0	((324/751).CCLS.) or ((324/752).CCLS.)) and (integrated adj1 circuit adj2 die and laser adj2 light)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:41
-	0	((324/751).CCLS.) or ((324/752).CCLS.)) and (integratednadj1 circuit adj2 die and laser adj2 light)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:42
-	1	((324/751).CCLS.) or ((324/752).CCLS.)) and (liquid adj1 crystal adj1 layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:43
-	1340081	(change near ("01 or 2").PN.) phase)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:44
-	1	((324/751).CCLS.) or ((324/752).CCLS.)) and (liquid adj1 crystal adj1 layer)) and ( (change near ("01 or 2").PN.) phase))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:54
-	93	((324/751).CCLS.) or ((324/752).CCLS.)) and (laser near3 light)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/25 16:55
-	97358	250/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/26 12:04
-	430	324/751	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/26 12:04

L Number	Hits	Search Text	DB	Time stamp
1	21478	((laser or beam near4 (light or pulse or pulsing))same (chip or die or circuit) and heat)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/27 10:33
2	0	324/750-767	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/27 10:34
3	9555	(324/750-767).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/27 10:34
5	19	((((laser or beam near4 (light or pulse or pulsing))same (chip or die or circuit) and heat)) and ((324/750-767).CCLS.)) and (liquid adj1 crystal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/27 10:41
4	142	((laser or beam near4 (light or pulse or pulsing))same (chip or die or circuit) and heat)) and ((324/750-767).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/27 11:11
6	2	6146014.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/27 11:11
-	430	324/751	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/24 16:57
-	430	324/751	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/24 16:59
-	362	324/752	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/24 16:59
-	665	324/751 or 324/752	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/24 16:59
-	169	(324/751 or 324/752) and (laser adj2 beam)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/24 17:05
-	458	((324/751 or 324/752) and (laser adj2 beam)) and liquid crystal	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/24 17:06
-	21	((324/751 or 324/752) and (laser adj2 beam)) and (liquid adj2 crystal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/10/24 17:06